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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/830,068	04/23/2004	Young Joon Ahn	YHK-0135	7680

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EXAMINER

DONG, DALEI

ART UNIT PAPER NUMBER

2879

DATE MAILED: 04/05/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary	Application No. 10/830,068	Applicant(s) AHN, YOUNG JOON	
	Examiner Dalei Dong	Art Unit 2879	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --
Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 27 January 2006.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1,3,5,7-9,11-13 and 26-39 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1,3,5,7-9,11-13 and 26-39 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☒ The drawing(s) filed on 23 April 2004 is/are: a) ☒ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☒ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☒ All b) ☐ Some * c) ☐ None of:
1. ☒ Certified copies of the priority documents have been received.
 2. ☐ Certified copies of the priority documents have been received in Application No. _____.
 3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____ |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| 3) <input checked="" type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date <u>1/27/2006</u> . | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on January 27, 2006 has been entered.

Double Patenting

2. Claim 38 is objected to under 37 CFR 1.75 as being a substantial duplicate of claim 26. When two claims in an application are duplicates or else are so close in content that they both cover the same thing, despite a slight difference in wording, it is proper after allowing one claim to object to the other as being a substantial duplicate of the allowed claim. See MPEP § 706.03(k).

Claim Rejections - 35 USC § 103

3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

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4. Claims 1, 3, 5, 7-9, 11 are rejected under 35 U.S.C. 103(a) as being unpatentable over U.S. Patent No. 6,514,111 to Ebihara of record in view of U.S. Patent No. 5,972,564 to Kawana.

Regarding to claim 1, Ebihara discloses in Figures 1 and 2A-2C, a plasma display panel (1), comprising: a first substrate (22); a second substrate (27) facing the first substrate (22) with a discharge space therebetween; a sealing layer (32) located between the first substrate (22) and the second substrate (27); and at least one of a buffer layer (24a) or a dielectric layer formed between the first substrate (22) and the sealing layer (32); and a protective film (26) formed on the at least one of the buffer layer (24a) or the dielectric layer.

Ebihara further discloses the buffer or dielectric layer (24) is formed by a low-melting-point glass paste mainly comprising PbO (see column 4, lines 27-38).

However, Ebihara does not specifically disclose the detailed composition of the dielectric layer as claimed.

The Kawana reference teaches a plasma display panel, having a glass frit layer, (see column 5, lines 23-25) composed of PbO at a ratio of 45% to 55%, B₂O₃ at a ratio of 10% to 20% and SiO₂ at a ratio of 15% to 25% (see column 5, lines 26-34) for the purpose of effectively forming a stable dielectric layer when different materials are used for forming bus electrodes in the plasma display panel.

Thus, it would have been obvious to one having ordinary skill in the art at the time the invention was made to have utilize the buffer layer of Kawana for the plasma display panel of Ebihara in order to effectively form a stable dielectric layer when

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different materials are used to form the bus electrodes in the plasma display panel.

Furthermore, it has been held that where the general conditions of a claim are disclosed in the prior art, discovering the optimum or workable ranges involves only routine skill in the art.

Regarding to claim 3, Ebihara discloses in Figures 1 and 2A-C, the buffer layer (24a) is formed by a low-melting-point glass paste mainly comprising lead oxide (see column 4, lines 27-38) and the first substrate (22) is made of glass which is a different material from that of the buffer layer and thus a range of thermal expansion coefficient of the buffer layer is different from a range of thermal expansion coefficient of the first substrate.

Regarding to claim 5, albeit, Ebihara discloses the buffer layer and the sealing layer both comprises mainly of PbO, however, Ebihara specifically discloses the buffer layer having a softening point of 580°C (see column 6, lines 41-53) and the sealing layer having a softening point of 400°C (see column 7, lines 37-48) and thus, the buffer layer and the sealing layer may comprises of the same material however with different component compositions. Therefore, a range of thermal expansion coefficient of the buffer layer is different from a range of thermal expansion coefficient of the sealing layer.

Regarding to claim 7, the thermal expansion coefficient of the first substrate is merely a property of the material used in manufacture the first substrate, and the property of the material does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations and thus this limitation has not given patentable weight.

Regarding to claim 8, the thermal expansion coefficient of the sealing layer is merely a property of the material used in manufacture the sealing layer, and the property of the material does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations and thus this limitation has not given patentable weight.

Regarding to claim 9, the thermal expansion coefficient of the buffer layer is merely a property of the material used in manufacture the buffer layer. The Examiner asserts that the prior art teaches the claimed composition of the buffer layer and thus the buffer layer of the prior art exhibits the claimed thermal expansion coefficient. Furthermore, the property of the material does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations and thus this limitation has not given patentable weight.

Regarding to claim 11, Ebihara discloses in Figures 1 and 2A-C, the dielectric layer (25) and the buffer layer (24a) such that the buffer layer (24a) is provided between

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the first substrate (22) and the dielectric layer (25) and such that the dielectric layer (25) is provided between the buffer layer (24a) and the protective film (26).

Regarding to claim 34, Kawana teaches a plasma display panel, having a glass frit layer, (see column 5, lines 23-25) composed of PbO at a ratio of 45% to 55%, B₂O₃ at a ratio of 10% to 20% and SiO₂ at a ratio of 15% to 25% (see column 5, lines 26-34) and the motivation to combine is the same as above.

Regarding to claim 35, the thermal expansion coefficient of the buffer layer is merely a property of the material used in manufacture the buffer layer. The Examiner asserts that the prior art teaches the claimed composition of the buffer layer and thus the buffer layer of the prior art exhibits the claimed thermal expansion coefficient. Furthermore, the property of the material does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations and thus this limitation has not given patentable weight.

Regarding to claim 36, Ebihara discloses in Figures 1 and 2A-C, the at least one of the buffer layer (24a) or the dielectric layer is the buffer layer (24a), and the dielectric layer (25) is formed on the buffer layer (24a) such that the buffer layer (24a) is provided between the first substrate (22) and the dielectric layer (25) and such that the dielectric layer (25) is provided between the buffer layer (24a) and the protective film (26).

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5. Claims 12 and 13 are rejected under 35 U.S.C. 103(a) as being unpatentable over U.S. Patent No. 6,514,111 to Ebihara of record in view of U.S. Patent No. 5,972,564 and in further view of U.S. Patent No. 6,261,144 to Nishiki of record.

Regarding to claim 12, Ebihara in view of Kawana discloses in Figures 1 and 2A-2C, a plasma display panel (1), comprising: a first substrate (22); a second substrate (27) facing the first substrate (22) with a discharge space therebetween; a sealing layer (32) located between the first substrate (22) and the second substrate (27); and at least one of a buffer layer (24a) or a dielectric layer formed between the first substrate (22) and the sealing layer (32); wherein the at least one of the buffer layer or the dielectric layer includes the following composition: PbO at a ratio of 45% to 55%, B₂O₃ at a ratio of 10% to 20% and SiO₂ at a ratio of 15% to 25%; and a protective film (26) formed on the at least one of the buffer layer (24a) or the dielectric layer.

However, Ebihara and Kawana does not disclose the buffer layer is formed to be extended from the dielectric layer.

The Nishiki reference teaches in Figure 7A, a plasma display panel having an upper dielectric layer (18) formed on the first substrate (14) and the buffer layer is formed to be extended from the upper dielectric layer (18) for the purpose of efficiently sealing of the plasma display panel.

Thus, it would have been obvious to one having ordinary skill in the art at the time the invention was made to have utilize the buffer layer of Kawana and the buffer layer extended from the upper dielectric layer of Nishiki for the plasma display panel of Ebihara in order to efficiently seal the plasma display panel.

Regarding to claim 13, Ebihara discloses the buffer layer (24) is separately formed of a different material from the upper dielectric layer (25) (see column 6, lines 34-65).

6. Claims 26-28, 30, 31, 38 and 39 are rejected under 35 U.S.C. 103(a) as being unpatentable over U.S. Patent No. 6,495,262 to Igeta of record in view of U.S. Patent No. 5,972,564 to Kawana.

Regarding to claim 26, Igeta discloses in Figures 1-4, a plasma display panel, comprising: a first substrate (1B); a second substrate (1A) arranged with respect to the first substrate (1B) such that a discharge space is provided therebetween; a sealing layer (22a) between the first substrate (1B) and second substrate (1A); and at least one of a buffer layer (22b) or dielectric layer formed between the first substrate (1B) and the sealing layer (22a).

However, Igeta does not disclose the at least one of the buffer layer or the dielectric layer has a thermal expansion coefficient greater or equal to $72 \times 10^{-7}/^{\circ}\text{C}$.

The Kawana reference teaches a plasma display panel, having a glass frit layer, (see column 5, lines 23-25) composed of PbO at a ratio of 45% to 55%, B₂O₃ at a ratio of 10% to 20% and SiO₂ at a ratio of 15% to 25% (see column 5, lines 26-34) for the purpose of effectively forming a stable dielectric layer when different materials are used for forming bus electrodes in the plasma display panel.

The thermal expansion coefficient of the buffer layer is merely a property of the material used in manufacture the buffer layer. The Examiner asserts that the prior art

teaches the claimed composition of the buffer layer and thus the buffer layer of the prior art exhibits the claimed thermal expansion coefficient. Furthermore, the property of the material does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations and thus this limitation has not given patentable weight.

Thus, it would have been obvious to one having ordinary skill in the art at the time the invention was made to have utilize the buffer layer of Kawana for the plasma display panel of Ebihara in order to effectively form a stable dielectric layer when different materials are used to form the bus electrodes in the plasma display panel. Furthermore, it has been held that where the general conditions of a claim are disclosed in the prior art, discovering the optimum or workable ranges involves only routine skill in the art.

Regarding to claim 27, Igeta discloses in Figures 1-4, the sealing layer (22a) extends in a longitudinal direction (vertical direction) from a first end to a second end, the first end located proximal to the first substrate (1B) and the second end located proximal to the second substrate (1A), the buffer layer (22b) provided only in the area between the first end of the sealing layer (22a) and the first substrate (1B).

Regarding to claim 28, Igeta discloses in Figures 1-4, another sealing layer (22a on the opposite end thereof) between the first substrate (1B) and the second substrate (1A); and another buffer layer (22b on the opposite end thereof) formed between the first substrate (1B) and the another sealing layer (22a on the opposite end thereof) such that

the another buffer layer (22b on the opposite end thereof) is provided only in another area between the first substrate (1B) and the another sealing layer (22a on the opposite end thereof), the another buffer layer (22b on the opposite end thereof) to compensate thermal stress of the first substrate (1B) and the another sealing layer (22a on the opposite end thereof).

Regarding to claim 30, Igeta discloses in Figures 1-4, a thermal expansion coefficient of the buffer layer (2B of 22b) is different from a thermal expansion coefficient of the first substrate (1B).

Regarding to claim 31, Igeta discloses in Figures 1-4, a thermal expansion coefficient of the buffer layer (2B of 22b) is different from a thermal expansion coefficient of the sealing layer (2A of 22a).

Regarding to claim 38, the thermal expansion coefficient of the buffer layer is merely a property of the material used in manufacture the buffer layer. The Examiner asserts that the prior art teaches the claimed composition of the buffer layer and thus the buffer layer of the prior art exhibits the claimed thermal expansion coefficient. Furthermore, the property of the material does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations and thus this limitation has not given patentable weight.

Regarding to claim 39, Kawana teaches a plasma display panel, having a buffer layer (glass frit layer, see column 5, lines 23-25) composed of PbO at a ratio of 45% to 55%, B₂O₃ at a ratio of 10% to 20% and SiO₂ at a ratio of 15% to 25% (see column 5, lines 26-34) and the motivation to combine is the same as above.

7. Claim 29 is rejected under 35 U.S.C. 103(a) as being unpatentable over U.S. Patent No. 6,495,262 to Igeta of record in view of U.S. Patent No. 5,972,564 to Kawana in further view of U.S. Patent No. 6,514,111 to Ebihara of record.

Regarding to claim 29, Igeta in view of Kawana discloses in Figures 1-4, a plasma display panel, comprising: a first substrate (1B); a second substrate (1A) arranged with respect to the first substrate (1B) such that a discharge space is provided therebetween; a sealing layer (22a) between the first substrate (1B) and second substrate (1A); and at least one of a buffer layer (22b) or dielectric layer formed between the first substrate (1B) and the sealing layer (22a) and wherein the at least one of the buffer layer or the dielectric layer has a thermal expansion coefficient greater or equal to $72 \times 10^{-7}/^{\circ}\text{C}$.

However, Igeta and Kawana does not specifically disclose the plasma display panel comprising an upper dielectric layer formed on the first substrate between the buffer layer and the another buffer layer; and a protective film formed on the upper dielectric layer.

Ebihara discloses in Figures 1 and 2A-C, an plasma display panel comprising: an upper dielectric layer (25) is formed on first substrate (22) between the buffer layer (24a) and the another buffer layer (32); and a protective film (26) is formed on the upper

dielectric layer (25) for the purpose of reducing the stress in the dielectric layer of the sealing region, there by the occurrence of flaws therein is avoided without reducing the thickness of the dielectric layer in the display region.

Thus, it would have been obvious to one having ordinary skill in the art at the time the invention was made to have utilize buffer layer of Kawana and the upper dielectric layer and a protective film of Ebihara for the plasma display panel of Igeta in order to reduce the stress in the dielectric layer of the sealing region, there by the occurrence of flaws therein is avoided without reducing the thickness of the dielectric layer in the display region.

8. Claims 32, 33 and 37 are rejected under 35 U.S.C. 103(a) as being unpatentable over U.S. Patent No. 6,514,111 to Ebihara.

Regarding to claim 32, Ebihara discloses in Figures 1 and 2A-C, a plasma display comprising: a first substrate (22); a second substrate (27) arranged with respect to the first substrate (22) such that a discharge space is provided therebetween; a sealing layer (32) between the first substrate (22) and the second substrate (27); at least one of a buffer layer (24a) or a dielectric layer provided on the first substrate (22) and provided between the first substrate (22) and the sealing layer (32); wherein the buffer layer has a thickness of 20 microns (see column 4, lines 59-64); and a protective film (26) on the at least one of the buffer layer (24a) or the dielectric layer.

Ebihara further disclose the center portion of the dielectric layer 4 having a thickness of about 40 microns for the purpose of permitting reduction of the electrostatic

capacity between the display electrodes, so that the power consumption for charging the electrostatic capacity upon later discharge becomes smaller, thus achieving a lower power consumption (see column 4, lines 49-56).

Thus, it would have been obvious to one having ordinary skill in the art at the time the invention was made to have construct the buffer layer of Ebihara having a thickness of 35 microns to 50 microns in order to permit reduction of the electrostatic capacity between the display electrodes, so that the power consumption for charging the electrostatic capacity upon later discharge becomes smaller, thus achieving a lower power consumption.

Regarding to claim 33, Ebihara discloses in Figures 1 and 2A-C, the buffer layer (24a) is different than the upper dielectric layer (25).

Regarding to claim 37, Ebihara discloses the dielectric layer having a thickness of 40 microns (see column 4, lines 49-56) and the motivation to combine is the same as above.

Response to Arguments

9. Applicant's arguments with respect to claims 1, 3, 5, 7-9, 11-13, 26-39 have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

10. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire **THREE MONTHS** from the mailing date of this action. In the event a first reply is filed within **TWO MONTHS** of the mailing date of this final action and the advisory action is not mailed until after the end of the **THREE-MONTH** shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than **SIX MONTHS** from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Dalei Dong whose telephone number is (571)272-2370. The examiner can normally be reached on 8 A.M. to 5 P.M..

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nimeshkumar Patel can be reached on (571)272-2457. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).



D.D.

March 30, 2006



Karabi Guharay
Primary Examiner
Art Unit 2879